

Dual Channel Small Outline Optoisolators Darlington Output

The MOCD223 device consists of two gallium arsenide infrared emitting diodes optically coupled to two monolithic silicon phototransistor darlington detectors, in a surface mountable, small outline, plastic package. It is ideally suited for high density applications that require low input current and eliminates the need for through-the-board mounting.

- Dual Channel Coupler
- Convenient Plastic SOIC–8 Surface Mountable Package Style
- High Output Current (I_C) (500% min) @ 1 mA Input Current
- Minimum $V_{(BR)CEO}$ of 30 Volts Guaranteed
- Standard SOIC–8 Footprint, with 0.050" Lead Spacing
- Compatible with Dual Wave, Vapor Phase and IR Reflow Soldering
- High Input–Output Isolation of 3000 Vac (rms) Guaranteed
- Meets U.L. Regulatory Requirements, File #E90700, Volume 2

Ordering Information:

- To obtain MOCD223 in tape and reel, add R2 suffix to device number as follows:
R2 = 2500 units on 13" reel
- To obtain MOCD223 in quantities of 50 (shipped in sleeves) — no suffix

Marking Information:

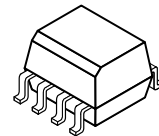
- MOCD223 = D223

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

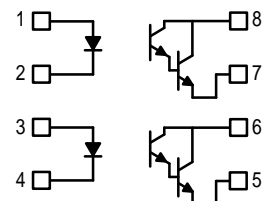
Rating	Symbol	Value	Unit
INPUT LED			
Forward Current — Continuous	I_F	60	mA
Forward Current — Peak (PW = 100 μs , 120 pps)	$I_{F(pk)}$	1.0	A
Reverse Voltage	V_R	6.0	V
LED Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	90 0.8	mW mW/ $^\circ\text{C}$
OUTPUT DARLINGTON			
Collector–Emitter Voltage	V_{CEO}	30	V
Collector–Base Voltage	V_{CBO}	70	V
Emitter–Collector Voltage	V_{ECO}	7.0	V
Collector Current — Continuous	I_C	150	mA
Detector Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	150 1.76	mW mW/ $^\circ\text{C}$

MOCD223

DUAL CHANNEL
SMALL OUTLINE
OPTOISOLATOR
DARLINGTON OUTPUT



SCHEMATIC



1. LED 1 ANODE
2. LED 1 CATHODE
3. LED 2 ANODE
4. LED 2 CATHODE
5. EMITTER 2
6. COLLECTOR 2
7. EMITTER 1
8. COLLECTOR 1

MAXIMUM RATINGS — continued ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
TOTAL DEVICE			
Input–Output Isolation Voltage ^(1,2) (60 Hz, 1.0 sec. duration)	V_{ISO}	3000	Vac(rms)
Total Device Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	250 2.94	mW mW/ $^\circ\text{C}$
Ambient Operating Temperature Range ⁽³⁾	T_A	-45 to +100	$^\circ\text{C}$
Storage Temperature Range ⁽³⁾	T_{stg}	-45 to +125	$^\circ\text{C}$
Lead Soldering Temperature (1/16" from case, 10 sec. duration)	—	260	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)⁽⁴⁾

Characteristic	Symbol	Min	Typ ⁽⁴⁾	Max	Unit
INPUT LED					
Forward Voltage ($I_F = 1.0\text{ mA}$)	V_F	—	1.05	1.3	V
Reverse Leakage Current ($V_R = 6.0\text{ V}$)	I_R	—	0.1	100	μA
Capacitance	C	—	18	—	pF

OUTPUT DARLINGTON

Collector–Emitter Dark Current	$(V_{CE} = 5.0\text{ V}, T_A = 25^\circ\text{C})$	I_{CEO1}	—	1.0	50	nA
	$(V_{CE} = 5.0\text{ V}, T_A = 100^\circ\text{C})$	I_{CEO2}	—	1.0	—	μA
Collector–Emitter Breakdown Voltage ($I_C = 100\ \mu\text{A}$)		$V_{(BR)CEO}$	30	90	—	V
Emitter–Collector Breakdown Voltage ($I_E = 100\ \mu\text{A}$)		$V_{(BR)ECO}$	7.0	7.8	—	V
Collector–Emitter Capacitance ($f = 1.0\text{ MHz}, V_{CE} = 0$)		C_{CE}	—	5.5	—	pF

COUPLED

Output Collector Current ($I_F = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}$)	MOCD223	$I_C\text{ (CTR)}^{(5)}$	5.0 (500)	10 (1000)	—	mA (%)
Collector–Emitter Saturation Voltage ($I_C = 500\ \mu\text{A}, I_F = 1.0\text{ mA}$)		$V_{CE(sat)}$	—	—	1.0	V
Turn–On Time ($I_F = 5.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$)		t_{on}	—	3.5	—	μs
Turn–Off Time ($I_F = 5.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$)		t_{off}	—	95	—	μs
Rise Time ($I_F = 5.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$)		t_r	—	1.0	—	μs
Fall Time ($I_F = 5.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$)		t_f	—	2.0	—	μs
Input–Output Isolation Voltage ($f = 60\text{ Hz}, t = 1.0\text{ sec.}$) ^(1,2)		V_{ISO}	3000	—	—	Vac(rms)
Isolation Resistance ($V_{I-O} = 500\text{ V}$) ⁽²⁾		R_{ISO}	10^{11}	—	—	Ω
Isolation Capacitance ($V_{I-O} = 0, f = 1.0\text{ MHz}$) ⁽²⁾		C_{ISO}	—	0.2	—	pF

1. Input–Output Isolation Voltage, V_{ISO} , is an internal device dielectric breakdown rating.
2. For this test, pins 1, 2, 3 and 4 are common, and pins 5, 6, 7 and 8 are common.
3. Refer to Quality and Reliability Section in Opto Data Book for information on test conditions.
4. Always design to the specified minimum/maximum electrical limits (where applicable).
5. Current Transfer Ratio (CTR) = $I_C/I_F \times 100\%$.

TYPICAL CHARACTERISTICS

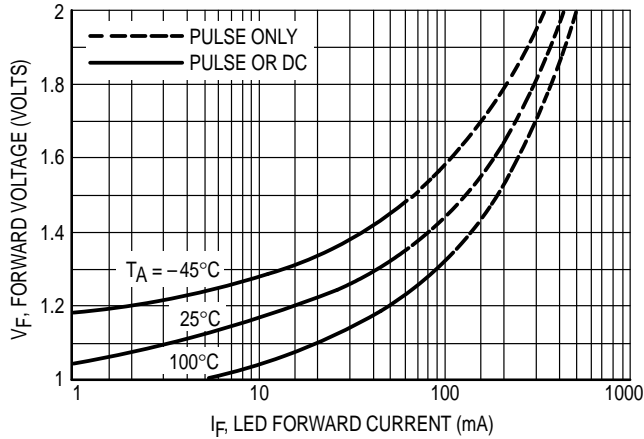


Figure 1. LED Forward Voltage versus Forward Current

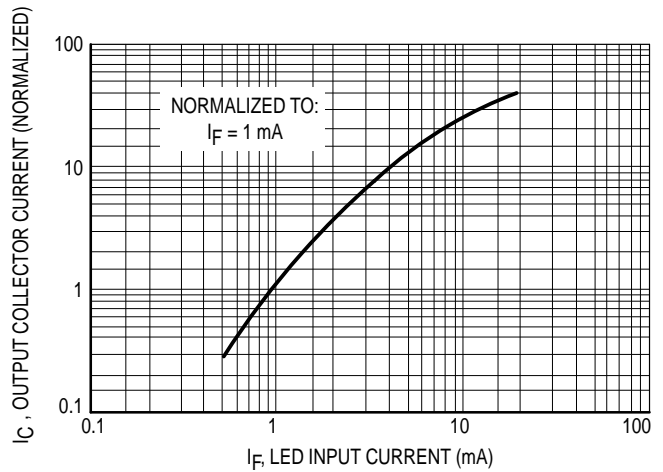


Figure 2. Output Current versus Input Current

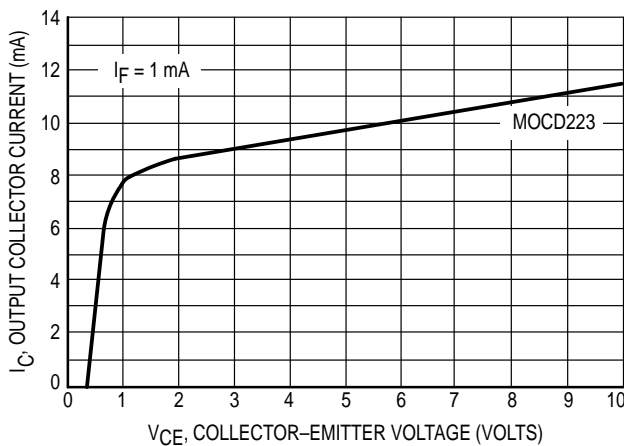


Figure 3. Output Current versus Collector-Emitter Voltage

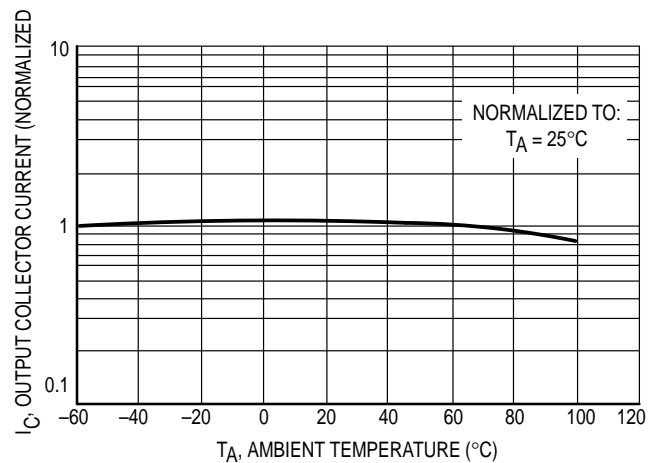


Figure 4. Output Current versus Ambient Temperature

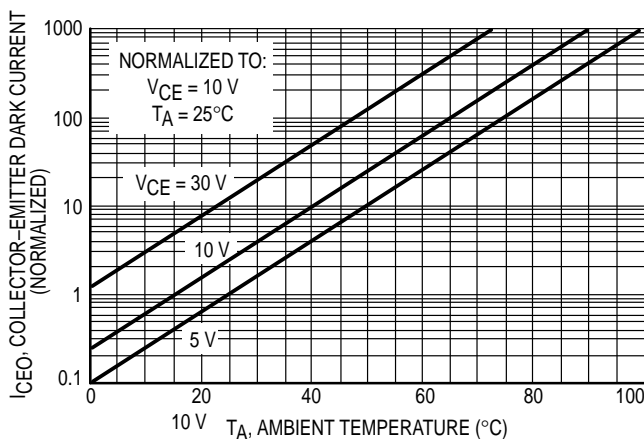


Figure 5. Dark Current versus Ambient Temperature

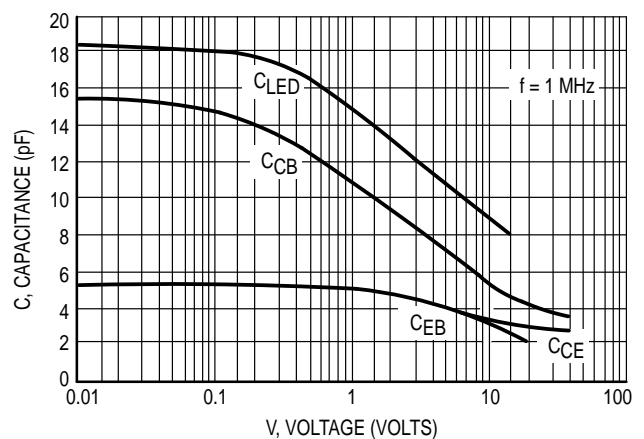
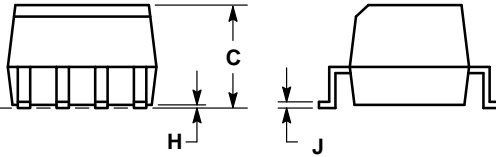
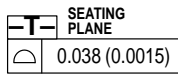
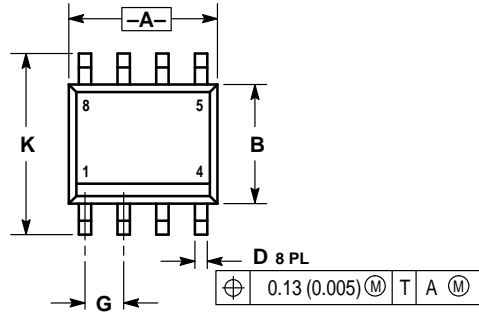


Figure 6. Capacitance versus Voltage

PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.182	0.202	4.63	5.13
B	0.144	0.164	3.66	4.16
C	0.123	0.143	3.13	3.63
D	0.011	0.021	0.28	0.53
G	0.050 BSC		1.27 BSC	
H	0.003	0.008	0.08	0.20
J	0.006	0.010	0.16	0.25
K	0.224	0.244	5.69	6.19

- STYLE 3:
PIN 1. ANODE 1
2. CATHODE 1
3. ANODE 2
4. CATHODE 2
5. EMITTER 2
6. COLLECTOR 2
7. EMITTER 1
8. COLLECTOR 1

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MOCD223-M

SO8 Dual Channel Photodarlington Coupler

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General description

The MOCD223 device consists of two gallium arsenide infrared emitting diodes optically coupled to two monolithic silicon phototransistor detectors, in a surface mountable, small outline, plastic package. They are ideally suited for high density applications and eliminate the need for through-the-board mounting.

- Dual channel coupler
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- High output current (I_C) (500% min) @ 1 mA input current
- Minimum $V_{(BR)CEO}$ of 30 volts guaranteed
- Standard SOIC - 8 footprint with a 0.050-inch lead spacing
- Compatible with dual wave, vapor phase and IR reflow soldering
- High input - Output isolation of 3000 VAC (RMS) guaranteed
- Underwriters Laboratory (UL) recognized - File #E90700, Volume 2

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Ordering information

The following options can be ordered with this part:

Option	Order Entry Identifier	Description
R1	R1	Surface-Mount Lead Bend Tape and Reel (500-pc reel)
R2	R2	Surface-Mount Lead Bend Tape and Reel (2500-pc reel)

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
MOCD223-M	Full Production	\$0.405	SOIC	8	RAIL
MOCD223R1-M	Full Production	\$0.413	SOIC	8	TAPE REEL
MOCD223R2-M	Full Production	\$0.413	SOIC	8	TAPE REEL

* 1,000 piece Budgetary Pricing

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Safety agency certificates

Certificate	Agency	
136616 (161 K)	VDE	VDE Pruf-und Zertifizierungsinstitut
E90700, Vol. 2 (254 K)	UL	Underwriters Laboratories Inc.

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Former Motorola Products Now Supplied by Fairchild

Select a product number to download its datasheet in PDF format ([Adobe Acrobat Reader](#) required). A -M suffix indicates a former Motorola product.

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4N29A-M replaced by 4N29	4N30-M replaced by 4N30	4N31-M replaced by 4N31
4N32-M replaced by 4N32	4N33-M replaced by 4N33	4N35-M
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4N38A-M replaced by 4N38		

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H11AV1A-M	H11AV2-M	H11AV2A-M
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H11D2-M replaced by H11D2	H11G1-M replaced by H11G1	H11G2-M replaced by H11G2
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H11L3-M		

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MOC213-M	MOC215-M	MOC216-M
MOC217-M	MOC223-M	MOC256-M
MOC3010-M	MOC3011-M	MOC3012-M
MOC3020-M	MOC3021-M	MOC3022-M
MOC3023-M	MOC3031-M	MOC3032-M
MOC3033-M	MOC3041-M	MOC3042-M
MOC3043-M	MOC3051-M	MOC3052-M
MOC3061-M	MOC3062-M	MOC3063-M
MOC3081-M	MOC3081-M	MOC3083-M
MOC3162-M	MOC3163-M	MOC5007-M
MOC5008-M	MOC5009-M	MOC8030-M replaced by MOC8030

MOC8050-M replaced by MOC8050	MOC8080-M replaced by MOC8080	MOC8100-M
MOC8204-M replaced by MOC8204	MOCD207-M	MOCD208-M
MOCD211-M	MOCD213-M	MOCD217-M
MOCD223-M		

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